

BGD902

860 MHz, 18.5 dB gain power doubler amplifier

Rev. 08 — 7 June 2007

Product data sheet

1. Product profile

1.1 General description

Hybrid amplifier module in a SOT115J package operating with a supply voltage of 24 V.

1.2 Features

- Excellent linearity
- Extremely low noise
- Excellent return loss properties
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability

1.3 Applications

- CATV systems operating in the 40 MHz to 900 MHz frequency range.

1.4 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|--------------------------------|---------------|------|------|------|------|
| G_p | power gain | $f = 50$ MHz | 18.2 | 18.5 | 18.8 | dB |
| | | $f = 900$ MHz | 19 | 19.5 | 20 | dB |
| I_{tot} | total current consumption (DC) | [1] | 405 | 420 | 435 | mA |

[1] The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 35 V.

2. Pinning information

Table 2. Pinning

| Pin | Description | Simplified outline | Symbol |
|------|-------------|--------------------|--------|
| 1 | input | | |
| 2, 3 | common | | |
| 5 | + V_B | | |
| 7, 8 | common | | |
| 9 | output | | |

3. Ordering information

Table 3. Ordering information

| Type number | Package | | Version |
|-------------|---------|--|---------|
| | Name | Description | |
| BGD902 | - | rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads | SOT115J |

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|---------------------------|------------|-----|------|------|
| V_B | supply voltage | | - | 30 | V |
| V_i | RF input voltage | | - | 70 | dBmV |
| T_{stg} | storage temperature | | -40 | +100 | °C |
| T_{mb} | mounting base temperature | | -20 | +100 | °C |

5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 900 MHz; $V_B = 24$ V; $T_{mb} = 35$ °C; $Z_S = Z_L = 75$ Ω.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------|--------------------------------|------------------------|------|-------|------|------|
| G_p | power gain | f = 50 MHz | 18.2 | 18.5 | 18.8 | dB |
| | | f = 900 MHz | 19 | 19.5 | 20 | dB |
| SL | slope cable equivalent | f = 40 MHz to 900 MHz | 0.4 | 0.9 | 1.4 | dB |
| FL | flatness of frequency response | f = 40 MHz to 900 MHz | - | ±0.15 | ±0.3 | dB |
| S_{11} | input return losses | f = 40 MHz to 80 MHz | 21 | 23 | - | dB |
| | | f = 80 MHz to 160 MHz | 22 | 24 | - | dB |
| | | f = 160 MHz to 320 MHz | 21 | 24 | - | dB |
| | | f = 320 MHz to 550 MHz | 18 | 23 | - | dB |
| | | f = 550 MHz to 650 MHz | 17 | 23 | - | dB |
| | | f = 650 MHz to 750 MHz | 16 | 24 | - | dB |
| | | f = 750 MHz to 900 MHz | 16 | 26 | - | dB |
| S_{22} | output return losses | f = 40 MHz to 80 MHz | 25 | 32 | - | dB |
| | | f = 80 MHz to 160 MHz | 23 | 31 | - | dB |
| | | f = 160 MHz to 320 MHz | 20 | 29 | - | dB |
| | | f = 320 MHz to 550 MHz | 20 | 28 | - | dB |
| | | f = 550 MHz to 650 MHz | 19 | 31 | - | dB |
| | | f = 650 MHz to 750 MHz | 18 | 29 | - | dB |
| | | f = 750 MHz to 900 MHz | 17 | 22 | - | dB |

Table 5. Characteristics ...continued

Bandwidth 40 MHz to 900 MHz; $V_B = 24\text{ V}$; $T_{mb} = 35\text{ °C}$; $Z_S = Z_L = 75\text{ }\Omega$.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|-----------|-----------------------------------|---|-----|-------|-------|-------|------|
| S_{21} | phase response | $f = 50\text{ MHz}$ | -45 | - | +45 | deg | |
| CTB | composite triple beat | 49 chs flat; $V_o = 47\text{ dBmV}$; $f_m = 859.25\text{ MHz}$ | - | -68.5 | -67 | dB | |
| | | 77 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 547.25\text{ MHz}$ | - | -70 | -68 | dB | |
| | | 110 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 745.25\text{ MHz}$ | - | -63.5 | -62 | dB | |
| | | 129 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 859.25\text{ MHz}$ | - | -60 | -58 | dB | |
| | | 110 chs; $f_m = 400\text{ MHz}$; $V_o = 49\text{ dBmV}$ at 550 MHz | [1] | - | -64 | -62 | dB |
| | | 129 chs; $f_m = 650\text{ MHz}$; $V_o = 49.5\text{ dBmV}$ at 860 MHz | [2] | - | -58.5 | -56.5 | dB |
| X_{mod} | cross modulation | 49 chs flat; $V_o = 47\text{ dBmV}$; $f_m = 55.25\text{ MHz}$ | - | -66.5 | -64 | dB | |
| | | 77 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 55.25\text{ MHz}$ | - | -69.5 | -67 | dB | |
| | | 110 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 55.25\text{ MHz}$ | - | -66 | -63.5 | dB | |
| | | 129 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 55.25\text{ MHz}$ | - | -64.5 | -62 | dB | |
| | | 110 chs; $f_m = 400\text{ MHz}$; $V_o = 49\text{ dBmV}$ at 550 MHz | [1] | - | -63 | -60 | dB |
| | | 129 chs; $f_m = 860\text{ MHz}$; $V_o = 49.5\text{ dBmV}$ at 860 MHz | [2] | - | -61 | -58 | dB |
| CSO | composite second order distortion | 49 chs flat; $V_o = 47\text{ dBmV}$; $f_m = 860.5\text{ MHz}$ | - | -65 | -62 | dB | |
| | | 77 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 548.5\text{ MHz}$ | - | -72 | -67 | dB | |
| | | 110 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 746.5\text{ MHz}$ | - | -65 | -60 | dB | |
| | | 129 chs flat; $V_o = 44\text{ dBmV}$; $f_m = 860.5\text{ MHz}$ | - | -61 | -58 | dB | |
| | | 110 chs; $f_m = 250\text{ MHz}$; $V_o = 49\text{ dBmV}$ at 550 MHz | [1] | - | -67 | -63 | dB |
| | | 129 chs; $f_m = 250\text{ MHz}$; $V_o = 49.5\text{ dBmV}$ at 860 MHz | [2] | - | -62 | -58 | dB |
| IMD2 | second order distortion | | [3] | - | -80 | -74 | dB |
| | | | [4] | - | -83 | -77 | dB |
| | | | [5] | - | -84 | -78 | dB |
| V_o | output voltage | IMD = -60 dB | [6] | 64.5 | 66 | - | dBmV |
| | | | [7] | 65.5 | 67 | - | dBmV |
| | | | [8] | 67.5 | 69 | - | dBmV |
| | | CTB compression = 1 dB; 129 chs flat; $f = 859.25\text{ MHz}$ | | 48.5 | 49.5 | - | dBmV |
| | | CSO compression = 1 dB; 129 chs flat; $f = 860.5\text{ MHz}$ | | 50 | 53 | - | dBmV |
| F | noise figure | $f = 50\text{ MHz}$ | - | 4.5 | 5 | dB | |
| | | $f = 550\text{ MHz}$ | - | 5 | 5.5 | dB | |
| | | $f = 750\text{ MHz}$ | - | 5.5 | 6.5 | dB | |
| | | $f = 900\text{ MHz}$ | - | 6.5 | 8 | dB | |
| I_{tot} | total current consumption (DC) | | [9] | 405 | 420 | 435 | mA |

[1] Tilt = 9 dB (50 MHz to 550 MHz); tilt = 3.5 dB at -6 dB offset (550 MHz to 750 MHz).

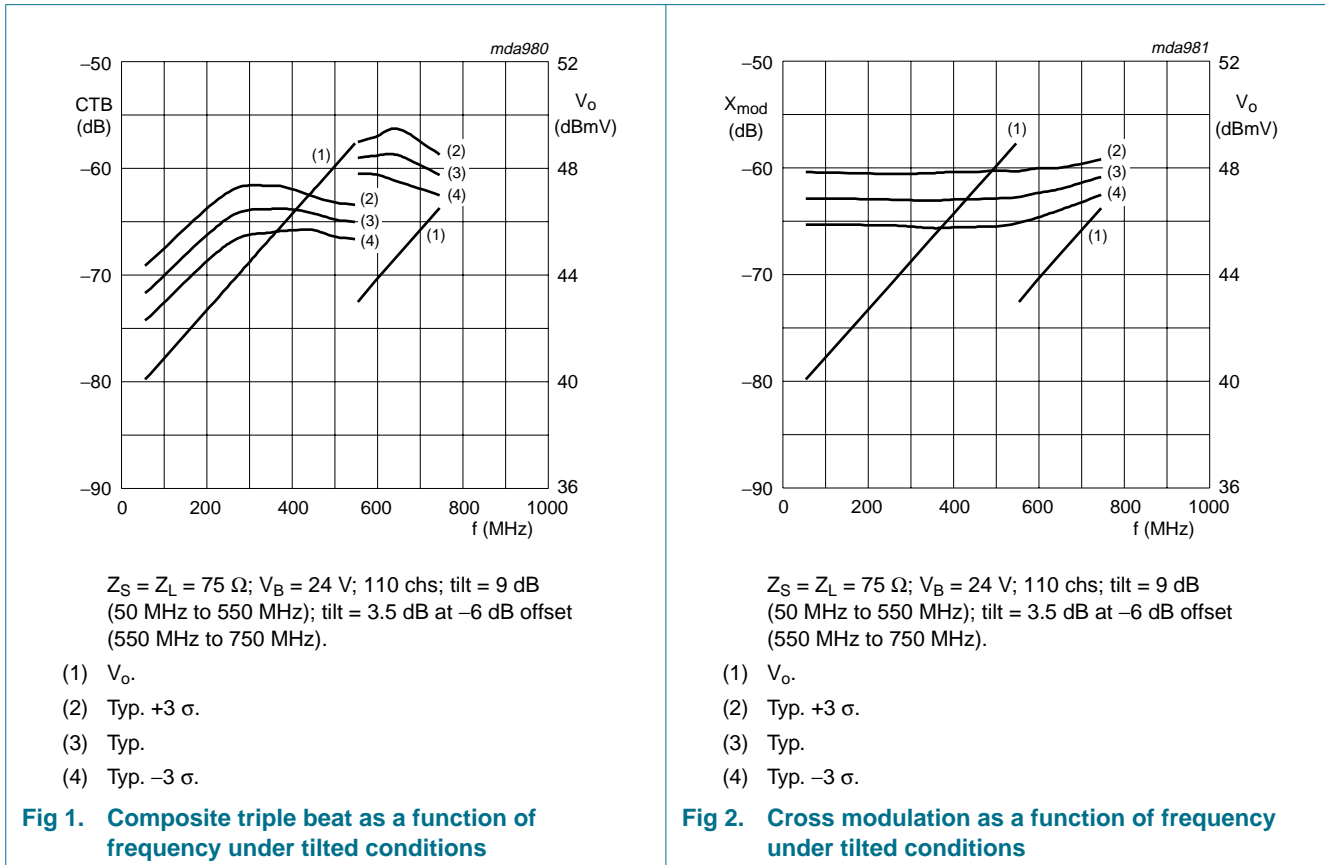
[2] Tilt = 12.5 dB (50 MHz to 860 MHz).

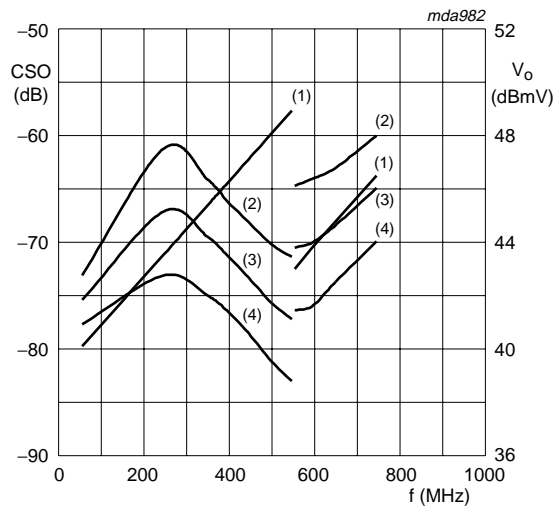
[3] $f_p = 55.25\text{ MHz}$; $V_p = 44\text{ dBmV}$; $f_q = 805.25\text{ MHz}$; $V_q = 44\text{ dBmV}$; measured at $f_p + f_q = 860.5\text{ MHz}$.

[4] $f_p = 55.25\text{ MHz}$; $V_p = 44\text{ dBmV}$; $f_q = 691.25\text{ MHz}$; $V_q = 44\text{ dBmV}$; measured at $f_p + f_q = 746.5\text{ MHz}$.

[5] $f_p = 55.25\text{ MHz}$; $V_p = 44\text{ dBmV}$; $f_q = 493.25\text{ MHz}$; $V_q = 44\text{ dBmV}$; measured at $f_p + f_q = 548.5\text{ MHz}$.

- [6] Measured according to DIN45004B: $f_p = 851.25$ MHz; $V_p = V_o$; $f_q = 858.25$ MHz; $V_q = V_o - 6$ dB; $f_r = 860.25$ MHz; $V_r = V_o - 6$ dB; measured at $f_p + f_q - f_r = 849.25$ MHz.
- [7] Measured according to DIN45004B: $f_p = 740.25$ MHz; $V_p = V_o$; $f_q = 747.25$ MHz; $V_q = V_o - 6$ dB; $f_r = 749.25$ MHz; $V_r = V_o - 6$ dB; measured at $f_p + f_q - f_r = 738.25$ MHz.
- [8] Measured according to DIN45004B: $f_p = 540.25$ MHz; $V_p = V_o$; $f_q = 547.25$ MHz; $V_q = V_o - 6$ dB; $f_r = 549.25$ MHz; $V_r = V_o - 6$ dB; measured at $f_p + f_q - f_r = 538.25$ MHz.
- [9] The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 35 V.

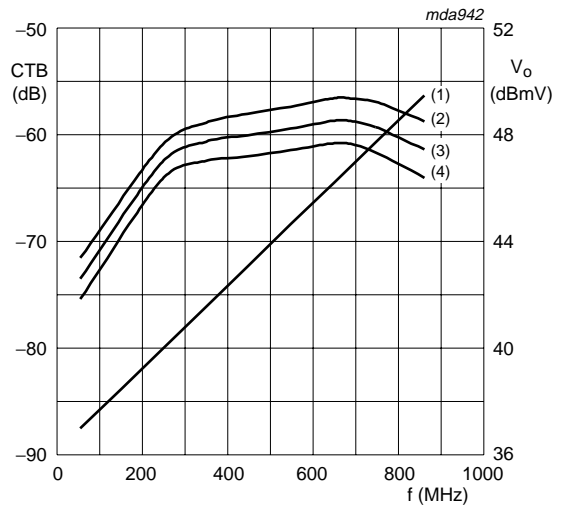




$Z_S = Z_L = 75 \Omega$; $V_B = 24 \text{ V}$; 110 chs; tilt = 9 dB (50 MHz to 550 MHz); tilt = 3.5 dB at -6 dB offset (550 MHz to 750 MHz).

- (1) V_o .
- (2) Typ. +3 σ .
- (3) Typ.
- (4) Typ. -3 σ .

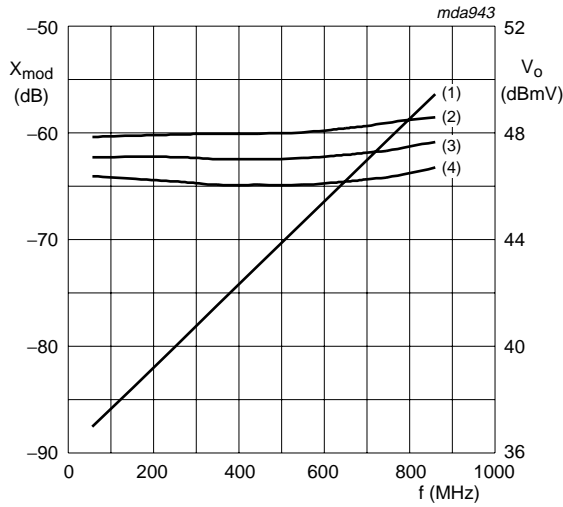
Fig 3. Composite second order distortion as a function of frequency under tilted conditions



$Z_S = Z_L = 75 \Omega$; $V_B = 24 \text{ V}$; 129 chs; tilt = 12.5 dB (50 MHz to 860 MHz).

- (1) V_o .
- (2) Typ. +3 σ .
- (3) Typ.
- (4) Typ. -3 σ .

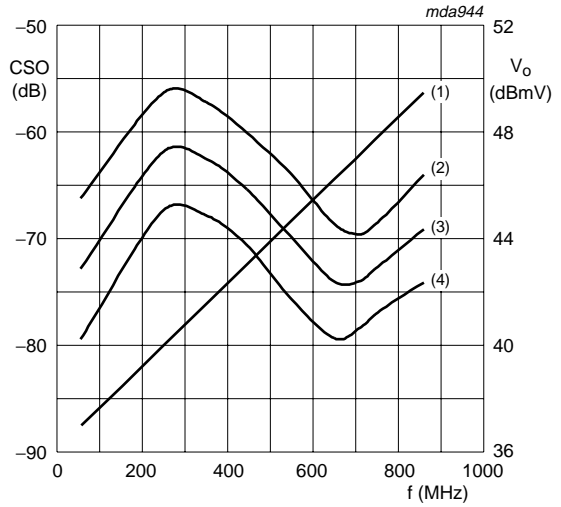
Fig 4. Composite triple beat as a function of frequency under tilted conditions



$Z_S = Z_L = 75 \Omega$; $V_B = 24 \text{ V}$; 129 chs; tilt = 12.5 dB
(50 MHz to 860 MHz).

- (1) V_o.
- (2) Typ. +3 σ.
- (3) Typ.
- (4) Typ. -3 σ.

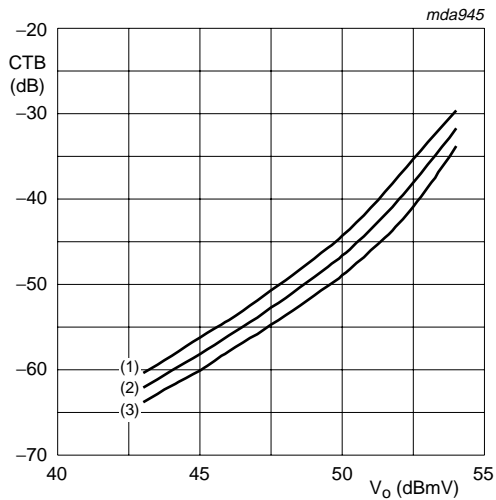
Fig 5. Cross modulation as a function of frequency under tilted conditions



$Z_S = Z_L = 75 \Omega$; $V_B = 24 \text{ V}$; 129 chs; tilt = 12.5 dB
(50 MHz to 860 MHz).

- (1) V_o.
- (2) Typ. +3 σ.
- (3) Typ.
- (4) Typ. -3 σ.

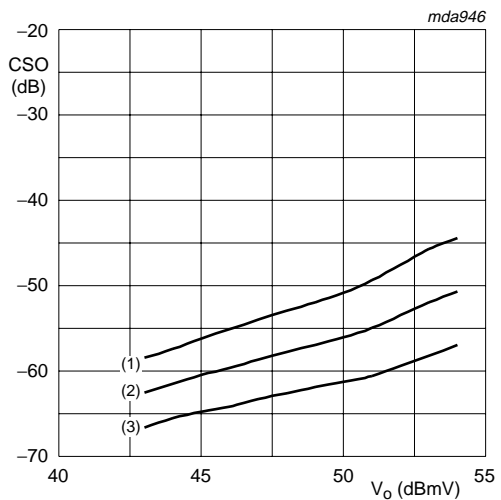
Fig 6. Composite second order distortion as a function of frequency under tilted conditions



$Z_S = Z_L = 75 \Omega$; $V_B = 24 \text{ V}$; 129 chs;
 $f_m = 859.25 \text{ MHz}$.

- (1) Typ. +3 σ.
- (2) Typ.
- (3) Typ. -3 σ.

Fig 7. Composite triple beat as a function of output voltage



$Z_S = Z_L = 75 \Omega$; $V_B = 24 \text{ V}$; 129 chs; $f_m = 860.5 \text{ MHz}$.

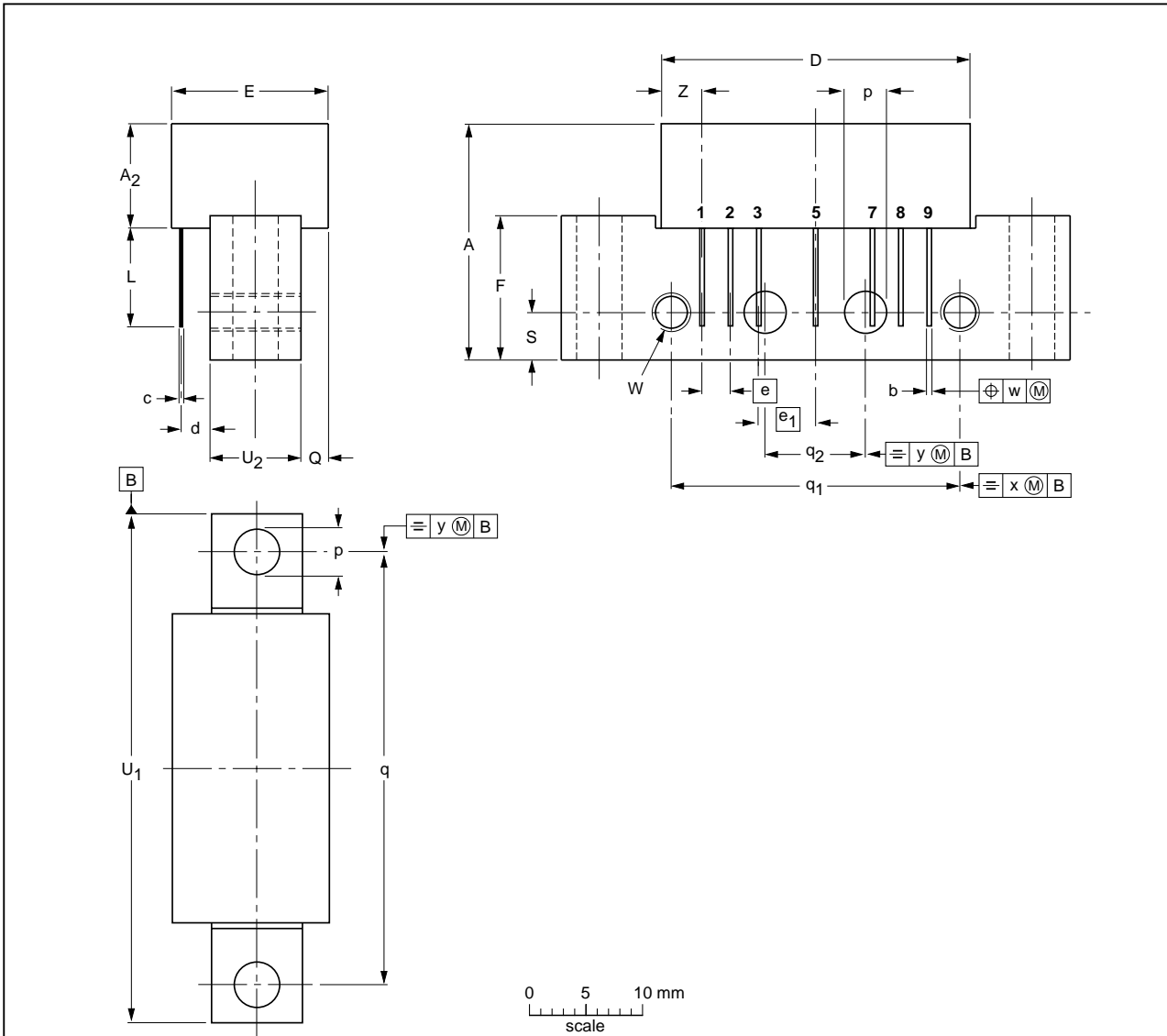
- (1) Typ. +3 σ.
- (2) Typ.
- (3) Typ. -3 σ.

Fig 8. Composite second order distortion as a function of output voltage

6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₂ max. | b | c | D max. | d max. | E max. | e | e ₁ | F | L min. | p | Q max. | q | q ₁ | q ₂ | S | U ₁ | U ₂ | W | w | x | y | Z max. |
|------|--------|---------------------|--------------|------|--------|--------|--------|------|----------------|------|--------|--------------|--------|------|----------------|----------------|-----|----------------|----------------|-------------|------|-----|-----|--------|
| mm | 20.8 | 9.1 | 0.51 0.38 | 0.25 | 27.2 | 2.54 | 13.75 | 2.54 | 5.08 | 12.7 | 8.8 | 4.15 3.85 | 2.4 | 38.1 | 25.4 | 10.2 | 4.2 | 44.75 44.25 | 8.2 7.8 | 6-32 UNC | 0.25 | 0.7 | 0.1 | 3.8 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|-------|--|---------------------|-----------------------|
| | IEC | JEDEC | JEITA | | | |
| SOT115J | | | | | | -99-02-06 04-02-04 |

Fig 9. Package outline SOT115J

7. Revision history

Table 6. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--------------|---------------------------|---------------|--|
| BGD902_8 | 20070607 | Product data sheet | | BGD902_7 |
| Modifications: | | | | |
| | | | | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Table 5 "Characteristics": updated values of s_{11} and s_{22}. |
| BGD902_7 | 20050308 | Product data sheet | | BGD902_902MI_6 |
| BGD902_902MI_6 | 20011102 | Product specification | | BGD902_902MI_5 |
| BGD902_902MI_5 | 19990329 | Product specification | | BGD902_N_3 and BGD902MI_N_1 |
| BGD902_N_3 | 19980709 | Preliminary specification | | BGD902_N_2 |
| BGD902_N_2 | 19980609 | Preliminary specification | | BGD902_1 |
| BGD902_1 | 19980312 | Preliminary specification | | - |
| BGD902MI_N_1 | 19980831 | Preliminary specification | | - |

8. Legal information

8.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 7 June 2007

Document identifier: BGD902_8